

Artifact Evaluation






ICSE 2023

About Accepted Research Artifacts .

Call For Artifact Submissions

Version 1.0, last modified 2021-12-15

The artifact evaluation track aims to review, promote, share, and catalog the research artifacts of accepted software engineering papers. Authors of papers accepted to the Technical/SEIP/NIER/SEET/SEIS tracks can submit an artifact for the Artifacts Evaluated and Artifacts Available badges. Authors of any prior SE work (published at ICSE or elsewhere) are also invited to submit their work for the Results Validated badges. Definitions for the badges are given in the table below, taken from ACM Artifact Review and Badging Version 1.1 (<https://www.acm.org/publications/policies/artifact-review-and-badging-current>) .

Artifacts Evaluated		Artifacts Available Results Validated		
Functional	Reusable	Available	Reproduced	Replicated
				
The artifacts associated with the research are found to be documented, consistent, complete, exercisable, and include appropriate evidence of verification and validation.		The artifacts associated with the paper are of a quality that significantly exceeds minimal functionality. That is, they have all the qualities of the Artifacts Evaluated – Functional level, but, in addition, they are very carefully documented and well-structured to the extent that reuse and repurposing is facilitated. In particular, norms and standards of the research community for artifacts of this type are strictly adhered to.		
		Author-created artifacts relevant to this paper have been placed on a publicly accessible archival repository. A DOI or link to this repository along with a unique identifier for the object is provided.	The main results of the paper have been independently obtained in a subsequent study by a person or team other than the authors, without the use of author-supplied artifacts.	The main results of the paper have been obtained in a subsequent study by a person or team other than the authors, using, in part, artifacts provided by the author.

Important Dates

- Jan 20, 2023: Artifact abstract deadline.
- Jan 27, 2023: Artifact submissions deadline.
- Jan 28 - Feb 7, 2023: 1st review period (PC only).
- Feb 7 - Feb 17, 2023: 2nd review period (PC/authors discussion).
- Feb 24, 2023: Notifications.

Best Artifact Awards

There will be two ICSE 2023 Best Artifact Awards to recognize the effort of authors creating and sharing outstanding research artifacts.

Submission for Results Validated Badges

For the two types of Results Validated badges (Replicated and Reproduced badges), authors will need to offer appropriate documentation that their artifacts have reached that stage.

By the submission deadline, register your research artifact at the ICSE 2023 HotCRP (<https://icse2023-artifact.hotcrp.com/>) site by submitting a 2 pages (max) abstract in PDF format describing your artifact.

The abstract should include the paper title, the purpose of the research artifact, the badge(s) you are claiming, and the technology skills assumed by the reviewer evaluating the artifact. Please also mention if running your artifact requires specific Operating Systems or other environments.

- **TITLE:** A (Partial) (Replication|Reproduction) of XYZ . Please add the term partial to your title if only part of the original work could be replicated/reproduced.
- **WHO:** name the original authors (and paper) and the authors that performed the replication/reproduction. Include contact information and mark one author as the corresponding author. **IMPORTANT :** include also a web link to a publically available URL directory containing (a) the original paper (that is being reproduced) and (b) any subsequent paper(s)/documents/reports that do the reproduction.
- **WHAT:** describe the “thing” being replicated/reproduced;
- **WHY:** clearly state why that “thing” is interesting/important;
- **HOW:** say how it was done first;
- **WHERE:** describe the replication/reproduction. If the replication/reproduction was only partial, then explain what parts could be achieved or had to be missed.
- **DISCUSSION** (if applicable): What aspects of this “thing” made it easier/harder to replicate/reproduce. What are the lessons learned from this work that would enable more replication/reproduction in the future for other kinds of tasks or other kinds of research.

At least two PC members will review each abstract, possibly reaching out to the authors of the abstract or original paper. Abstracts will be ranked as follows.

- If PC members do not find sufficient substantive evidence for replication/reproduction, the abstract will be rejected.
- The remaining abstracts will be sorted according to (a) correctness and (b) how interesting they are to the community (relevance).
- The top ranked abstracts will be invited to give lightning talks.

Submission for Evaluated and Available Badges

Only authors of papers accepted to the 2023 Technical/SEIP/NIER/SEET/SEIS tracks can submit candidate reusable or available artifacts.

By the submission deadline, register your research artifact at the ICSE 2023 HotCRP (<https://icse2023-artifact.hotcrp.com/>) site by submitting a 2 pages (max) abstract in PDF format describing your artifact.

For the evaluated and available badges, authors must offer “download information” showing how reviewers can access and execute (if appropriate) their artifact.

Authors must perform the following steps to submit an artifact:

1. Prepare the artifact
2. Make the artifact available
3. Document the artifact
4. Submit the artifact

1. Prepare the artifact

There are two options depending on the nature of the artifacts: Installation Package or Simple Package. In both cases, the configuration and installation for the artifact should take less than 30 minutes. Otherwise, the artifact is unlikely to be accepted on practical grounds, simply because the PC will not have sufficient time to evaluate it.

- **Installation Package.** If the artifact consists of a tool or software system, then the authors need to prepare an installation package so that the tool can be installed and run in the evaluator’s environment. Provide enough associated instruction, code, and data such that an average CS professional could build, install, and run the code. If the artifact contains or requires the use of a special tool or any other non-trivial piece of software, the authors must provide a VirtualBox VM image or a Docker container image with a working environment containing the artifact and all the necessary tools. We expect artifacts to have been vetted on a clean machine before submission.
- **Simple Package.** If the artifact only contains documents which can be used with a simple text editor, a PDF viewer, or some other common tool (e.g., a spreadsheet program in its basic configuration) the authors can just save all documents in a single package file (zip or tar.gz).

2. Make the artifact available

The authors need to make the packaged artifact (installation package or simple package) available so that the PC can access it.

We recommend making artifacts available via an archival repository, such as Software Heritage (<https://www.softwareheritage.org/>) (see submission guide (<https://www.softwareheritage.org/2019/08/05/saving-and-referencing-research-software-in-software-heritage/>)), which provides long-term availability of software source code. Other often used solutions, more focused on long-term data archival, include Figshare (<https://figshare.com/>) and Zenodo (<https://zenodo.org/>).

We recommend against making artifacts available solely on collaborative software development platforms, as they do not guarantee long-term archival. Also, availability via an archival repository is a mandatory requirement for papers aiming for the Available badge.

For papers aiming for the Functional and Reusable badges (but not the Available badge), it is possible to provide a private link or a password-protected link to the submitted artifact, in order to enable reviewers to privately review it. While these mechanisms are supported, in the spirit of the ICSE Open Science Policy (<https://conf.researchr.org/track/icse-2023/icse-2023-technical-track#ICSE-2023-open-science-policy>), we recommend against them and encourage authors to make their artifacts publicly available, no matter which badges they are after.

3. Document the artifact

The authors need to write and submit documentation explaining how to obtain, unpack, and use the artifact in more detail. The artifact submission must only describe the technicalities of the artifacts and uses of the artifact that are not already described in the paper.

The submission should include the following documents (in plain text or pdf format) in a single archive file:

- A README file describing what the artifact does and where it can be obtained. Also, there should be a clear description of how to repeat/replicate/reproduce the results presented in the paper. Artifacts which focus on data should, in principle, cover aspects relevant to understanding the context, data provenance, ethical and legal statements (as long as relevant), and storage requirements. Artifacts which focus on software should, in principle, cover aspects relevant to how to install and use it (and be accompanied by a small example).

- A REQUIREMENTS file for artifacts which focus on software. This file should cover aspects of hardware (e.g., performance, storage or non-commodity peripherals) and software environments (e.g., Docker, VM, and operating system; package dependencies, etc.). Any deviation from standard environments needs to be reasonably justified.
- A STATUS file stating what kind of badge(s) the authors are applying for as well as the reasons why the authors believe that the artifact deserves that badge(s).
- A LICENSE file describing the distribution rights. For submissions aiming for the Available badge, the license needs to ensure public availability. In the spirit of the ICSE Open Science Policy (<https://conf.researchr.org/track/icse-2023/icse-2023-technical-track#ICSE-2023-open-science-policy>) , we recommend adopting an open source license (<https://opensource.org/licenses>).
- An INSTALL file with installation instructions. These instructions should include notes illustrating a very basic usage example or a method to test the installation. This could be, for instance, on what output to expect that confirms that the code is installed and working; and the code is doing something interesting and useful.
- A copy of the accepted paper in pdf format.

4. Submit the artifact

By the submission deadline, register your research artifact at the ICSE 2023 HotCRP (<https://icse2023-artifact.hotcrp.com/>) site by submitting an abstract describing your artifact. The abstract should include the paper title, the purpose of the research artifact, the badge(s) you are claiming, and the technology skills assumed by the reviewer evaluating the artifact. Please also mention if running your artifact requires specific Operation Systems or other environments.

The PC may contact the authors, via the submission system, during the 2nd review period to request clarifications on the basic installation and start-up procedures or to resolve simple installation problems. Information on this phase is provided in the Submission and Reviewing Guidelines. Given the short review time available, the authors are expected to respond within a 48-hour period. Authors may update their research artifact after submission only for changes requested by reviewers in the 2nd review period (PC/author discussion phase).

Further information will be constantly made available on the website <https://conf.researchr.org/track/icse-2023/icse-2023-artifact-evaluation> (<https://conf.researchr.org/track/icse-2023/icse-2023-artifact-evaluation>) .

In case of questions, please do not hesitate contacting the chairs.

Review Guidelines

For PC members, please refer to the excellent ESEC/FSE'2021 guidelines for artifacts evaluation criteria (https://conf.researchr.org/getImage/icse-2023/orig/fse_artifacts_submission_reviewing_guidelines.pdf) (the entire document is applicable also for ICSE 2023, with the notable exception of different deadline dates).

Important Dates 🌐🕒 AoE (UTC-12h)
Fri 24 Feb 2023 Notifications
Tue 7 - Fri 17 Feb 2023 2nd review period (PC/authors discussion)
Sat 28 Jan 12:00 - Tue 7 Feb 12:00 2023 1st review period (PC only)
Fri 27 Jan 2023 Artifact submissions deadline
Fri 20 Jan 2023 Artifact abstract deadline

Submission Link

<https://icse2023-artifact.hotcrp.com/> (<https://icse2023-artifact.hotcrp.com/>)

Artifact Evaluation (<https://conf.researchr.org/committee/icse-2023/icse-2023-artifact-evaluation-artifact-evaluation>)



Stefano Zacchioli
Télécom Paris, Polytechnic Institute of Paris
France

Artifacts Co-chairs

(<https://conf.researchr.org/profile/icse-2023/stefanozacchioli>)



Minghui Zhou
Peking University
China

Artifacts Co-chairs

(<https://conf.researchr.org/profile/icse-2023/minghuizhou>)



Tiago Amorim
University of Cologne
Germany

(<https://conf.researchr.org/profile/icse-2023/tiagoamorim1>)



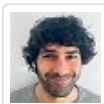
Gemma Catolino
Jheronimus Academy of Data Science
Netherlands

(<https://conf.researchr.org/profile/icse-2023/gemmacatolino>)



Jialiang Chang
CertiK
United States

(<https://conf.researchr.org/profile/icse-2023/jialiangchang>)



Valerio Cosentino
Eventbrite
Spain

(<https://conf.researchr.org/profile/icse-2023/valeriosentino>)



Istvan David
Université de Montréal
Canada

(<https://conf.researchr.org/profile/icse-2023/istvandavid1>)



Tapajit Dey
Carnegie Mellon University Software Engineering Institute
United States

(<https://conf.researchr.org/profile/icse-2023/tapajitdey>)



Angelo Di Iorio
University of Bologna

(<https://conf.researchr.org/profile/icse-2023/angelodiiorio>)



Dario Di Nucci
University of Salerno
Italy

(<https://conf.researchr.org/profile/icse-2023/dariodinucci>)



Davide Fucci
Blekinge Institute of Technology
Sweden

(<https://conf.researchr.org/profile/icse-2023/davidefucci>)



Kai Gao
Peking University
China

(<https://conf.researchr.org/profile/icse-2023/kaigao>)



Ilias Gerostathopoulos
Vrije Universiteit Amsterdam
Netherlands

(<https://conf.researchr.org/profile/icse-2023/iliasgerostathopoulos>)



Gouri Ginde Deshpande
University of Calgary

(<https://conf.researchr.org/profile/icse-2023/gourigindedeshpande>)



Hao He
Peking University
China

(<https://conf.researchr.org/profile/icse-2023/haohe>)



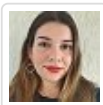
Kaifeng Huang
Fudan University

(<https://conf.researchr.org/profile/icse-2023/kaifenghuang1>)



Sylwia Kopczyńska
Poznan University of Technology
Poland

(<https://conf.researchr.org/profile/icse-2023/sylwiakopczynska>)



Zoe Kotti
Athens University of Economics and Business
Greece

(<https://conf.researchr.org/profile/icse-2023/zoekotti>)



Raula Gaikovina Kula
Nara Institute of Science and Technology
Japan

(<https://conf.researchr.org/profile/icse-2023/raulakula>)



Guangtai Liang
Huawei Cloud
China

(<https://conf.researchr.org/profile/icse-2023/guangtailiang>)



Xiapu Luo
The Hong Kong Polytechnic University
China

(<https://conf.researchr.org/profile/icse-2023/xiapuluo>)



Phuong T. Nguyen
University of L'Aquila

Italy

(<https://conf.researchr.org/profile/icse-2023/phuongtnguyen>)



Silvio Peroni
University of Bologna

Italy

(<https://conf.researchr.org/profile/icse-2023/silvioperoni>)



Tim Puhlfürß
Universität Hamburg

Germany

(<https://conf.researchr.org/profile/icse-2023/timpuhlfur>)



Davide Rossi
University of Bologna

(<https://conf.researchr.org/profile/icse-2023/daviderossi>)



Daniel Russo
Department of Computer Science, Aalborg University

Denmark

(<https://conf.researchr.org/profile/icse-2023/danielrusso1>)



Mersedeh Sadeghi
University of Cologne

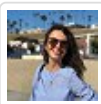
(<https://conf.researchr.org/profile/icse-2023/mersehehsadeghi>)



Gian Luca Scoccia
University of L'Aquila

Italy

(<https://conf.researchr.org/profile/icse-2023/gianlucascoccia1>)



Adriana Sejfia
University of Southern California

United States

(<https://conf.researchr.org/profile/icse-2023/adrianasejfia>)



Lin Shi
ISCAS

China

(<https://conf.researchr.org/profile/icse-2023/linshi>)



Amjed Tahir
Massey University

New Zealand

(<https://conf.researchr.org/profile/icse-2023/amjedtahir>)



Xin Tan
Beihang University,

China

(<https://conf.researchr.org/profile/icse-2023/xintan>)

Yuxin Tang

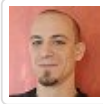
**Rice University**

(<https://conf.researchr.org/profile/icse-2023/yuxintang>)

**Catia Trubiani**
Gran Sasso Science Institute

Italy

(<https://conf.researchr.org/profile/icse-2023/catiatrubiani1>)

**Roberto Verdecchia**
University of Florence

Italy

(<https://conf.researchr.org/profile/icse-2023/robertoverdecchia>)

**Colin Werner**
University of Victoria

Canada

(<https://conf.researchr.org/profile/icse-2023/colinwerner>)

**Mairieli Wessel**
Radboud University

Netherlands

(<https://conf.researchr.org/profile/icse-2023/mairieliwessel>)

**Stefan Winter**
LMU Munich

Germany

(<https://conf.researchr.org/profile/icse-2023/stefanwinter>)

**Man Zhang**
Kristiania University

(<https://conf.researchr.org/profile/icse-2023/manzhang>)

**Yuxia Zhang**
Beijing Institute of Technology

China

(<https://conf.researchr.org/profile/icse-2023/yuxiazhang1>)

**Théo Zimmermann**
Télécom Paris, Polytechnic Institute of Paris

France

(<https://conf.researchr.org/profile/icse-2023/theozimmermann>)